



# LSM330DL

## Linear sensor module 3D accelerometer sensor and 3D gyroscope sensor

Preliminary data

### Features

- Analog supply voltage 2.4 V to 3.6 V
- Digital supply voltage I/Os, 1.8V
- Low-power mode
- Power-down mode
- 3 independent acceleration channels and 3 angular rate channels
- $\pm 2g/\pm 4g/\pm 8g/\pm 16g$  dynamic, selectable full-scale acceleration range
- $\pm 250/\pm 500/\pm 2000$  dps dynamic, selectable full-scale angular rate
- SPI/I<sup>2</sup>C serial interface (16-bit data output)
- Programmable interrupt generator for free-fall and motion detection
- ECOPACK<sup>®</sup>, RoHS, and “Green” compliant

### Applications

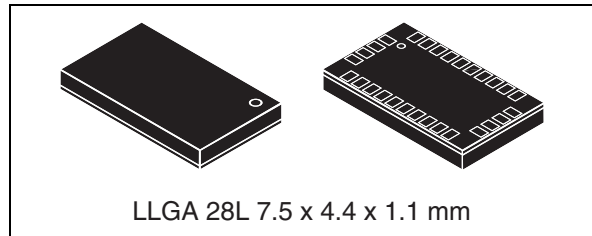
- GPS navigation systems
- Impact recognition and logging
- Gaming and virtual reality input devices
- Motion-activated functions
- Intelligent power saving for handheld devices
- Vibration monitoring and compensation
- Free-fall detection
- 6D-orientation detection

### Description

The LSM330DL is a system-in-package featuring a 3D digital accelerometer and a 3D digital gyroscope.

Table 1. Device summary

Part number	Temperature range [°C]	Package	Packing
LSM330DL	-40 to +85	LGA-28	Tray
LSM330DLTR	-40 to +85	LGA-28	Tape & reel



ST's family of modules leverages a robust and mature manufacturing process already used for the production of micromachined accelerometers.

The various sensing elements are manufactured using specialized micromachining processes, while the IC interfaces are based on CMOS technology that allows designing a dedicated circuit which is trimmed to better match the sensing element characteristics.

The LSM330DL has a dynamic, user-selectable full-scale acceleration range of  $\pm 2g/\pm 4g/\pm 8g/\pm 16g$  and an angular rate of  $\pm 250/\pm 500/\pm 2000$  deg/sec.

The accelerometer and gyroscope sensors can be either activated or put in low-power / power-down mode separately for power-saving optimized applications. The LSM330DL is available in a plastic land grid array (LGA) package.

Several years ago ST successfully pioneered the use of this package for accelerometers. Today, ST has the broadest manufacturing capability in the world and unrivalled expertise for the production of sensors in a plastic LGA package.

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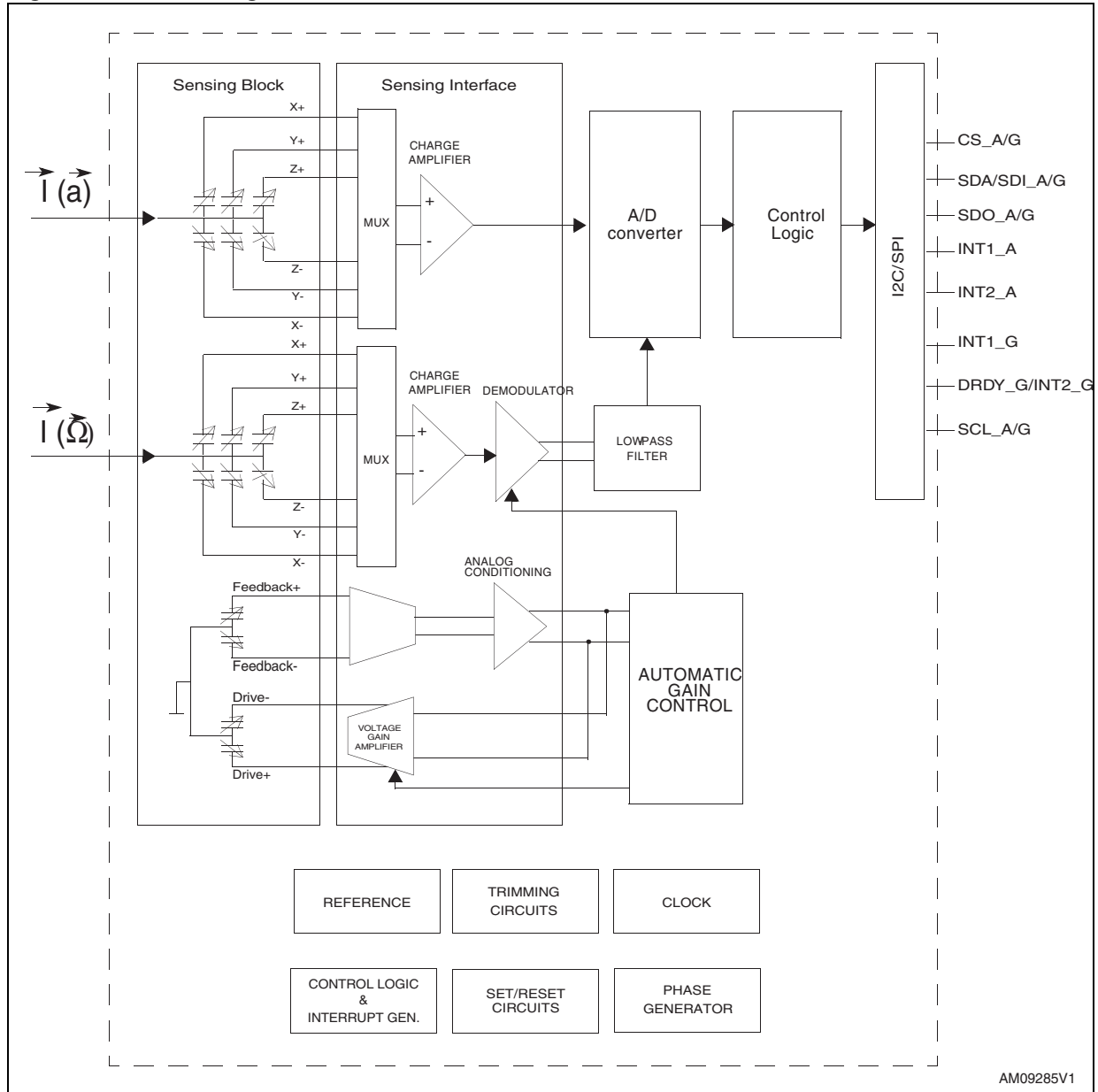
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# 1 Block diagram and pin description

## 1.1 Block diagram

Figure 1. Block diagram



## 1.2 Pin description

Figure 2. Pin connections

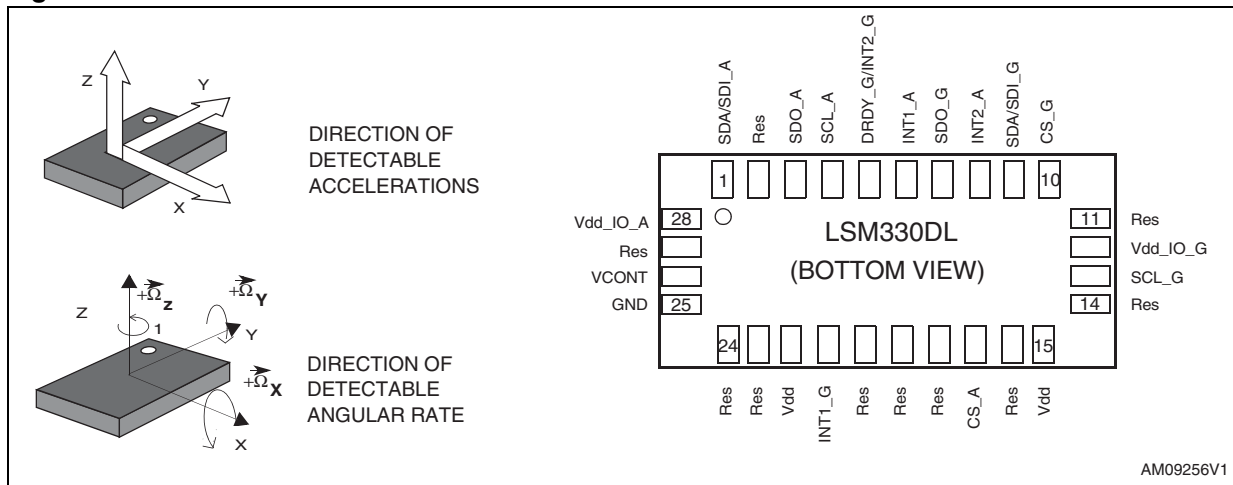


Table 2. Pin description

Pin#	Name	Function
1	SDA/SDI_A	Accelerometer: I <sup>2</sup> C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)
2	Res	Reserved, connect to GND
3	SDO_A	Accelerometer: SPI serial data output (SDO) I <sup>2</sup> C least significant bit of the device address (SA0)
4	SCL_A	Accelerometer: I <sup>2</sup> C serial clock (SCL) SPI serial port clock (SPC)
5	DRDY_G/INT2_G	Gyroscope data ready/interrupt signal 2
6	INT1_A	Accelerometer interrupt signal
7	SDO_G	Gyroscope: SPI serial data output (SDO) I <sup>2</sup> C least significant bit of the device address (SA0)
8	INT2_A	Accelerometer interrupt signal
9	SDA/SDI_G	Gyroscope: I <sup>2</sup> C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)

Table 2. Pin description (continued)

Pin#	Name	Function
10	CS_G	Gyroscope: SPI enable I <sup>2</sup> C/SPI mode selection (1: SPI idle mode / I <sup>2</sup> C communication enabled; 0: SPI communication mode / I <sup>2</sup> C disabled)
11	Res	Reserved, connect to GND
12	Vdd_IO_G	Gyroscope power supply for I/O pins
13	SCL_G	Gyroscope: I <sup>2</sup> C serial clock (SCL) SPI serial port clock (SPC)
14	Res	Reserved connect to GND
15	Vdd	Power supply
16	Res	Reserved, connect to GND
17	CS_A	Accelerometer: SPI enable I <sup>2</sup> C/SPI mode selection (1: SPI idle mode / I <sup>2</sup> C communication enabled; 0: SPI communication mode / I <sup>2</sup> C disabled)
18	Res	Reserved, connect to GND
19	Res	Reserved, connect to GND
20	Res	Reserved, connect to GND
21	INT1_G	Gyroscope interrupt signal 1
22	Vdd	Power supply
23	Res	Reserved, connect to GND
24	Res	Reserved, connect to GND
25	GND	0 V power supply
26	VCONT	PLL filter connection
27	Res	Reserved, connect to GND
28	Vdd_IO_A	Accelerometer power supply for I/O pins

## 2 Module specifications

### 2.1 Mechanical characteristics

The values given in the following table are for the conditions Vdd = 3 V, T = 25 °C unless otherwise noted.<sup>(a)</sup>

**Table 3. Mechanical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ. <sup>(1)</sup>	Max.	Unit
LA_FS	Linear acceleration measurement range <sup>(2)</sup>	FS bit set to 00		±2		g
		FS bit set to 01		±4		
		FS bit set to 10		±8		
		FS bit set to 11		±16		
G_FS	Angular rate measurement range <sup>(2)</sup>	FS bit set to 00		±250		dps
		FS bit set to 01		±500		
		FS bit set to 10		±2000		
LA_So	Linear acceleration sensitivity	FS bit set to 00		1		mg/digit
		FS bit set to 01		2		
		FS bit set to 10		4		
		FS bit set to 11		12		
G_So	Angular rate sensitivity	FS bit set to 00		8.75		mdps/digit
		FS bit set to 01		17.5		
		FS bit set to 10		70		
LA_So	Linear acceleration Sensitivity change vs. temperature	FS bit set to 00		±0.05		%/°C
G_So	Angular rate sensitivity change vs. temp.	from -40 to +85°C		±2		%
LA_TyOff	Typical zero-g level offset accuracy <sup>(3)</sup>	FS bit set to 00		±60		mg
G_TyOff	Typical zero-rate level <sup>(4)</sup>	FS bit set to 00		10		LSb
LA_TCOff	Zero-g level change vs. temperature	Max delta from 25 °C		±0.5		mg/°C
G_TCOff	Zero-rate level change vs. temperature	FS bit set to 00 from -40 to +85°C		±0.03		dps/°C
An	Acceleration noise density	FS bit set to 00, normal mode, ODR bit set to 1001		220		µg/√Hz
Rn	Rate noise density	FS bit set to 00, BW = 50 Hz		0.03		dps/√Hz
Top	Operating temperature range		-40		+85	°C

1. Typical specifications are not guaranteed.
2. Verified by wafer level test and measurement of initial offset and sensitivity.
3. Typical zero-g level offset value after MSL3 preconditioning.
4. Offset can be eliminated by enabling the built-in high-pass filter.

a. The product is factory calibrated at 3 V. The operational power supply range is from 2.4 V to 3.6 V.

## 2.2 Electrical characteristics

The values given in the following table are for the conditions  $V_{dd} = 3\text{ V}$ ,  $T = 25\text{ °C}$  unless otherwise noted.

**Table 4. Electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ. <sup>(1)</sup>	Max.	Unit
Vdd	Supply voltage		2.4		3.6	V
Vdd_IO	Power supply for I/O		1.71		$V_{dd}+0.1$	V
LA_Idd	LA current consumption in normal mode	ODR = 50 Hz		11		μA
		ODR = 1 Hz		2		
LA_IddLowP	LA current consumption in low-power mode	ODR = 50 Hz		6		μA
LA_IddPdn	LA current consumption in power-down mode	$T = 25\text{ °C}$		0.5		μA
G_Idd	AR current consumption in normal mode			6.1		mA
G_IddLowP	AR supply current in sleep mode <sup>(2)</sup>			1.5		mA
G_IddPdn	AR current consumption in power-down mode	$T = 25\text{ °C}$		5		μA
VIH	Digital high-level input voltage		$0.8 \cdot V_{dd\_IO}$			V
VIL	Digital low-level input voltage				$0.2 \cdot V_{dd\_IO}$	V
VOH	High-level output voltage		$0.9 \cdot V_{dd\_IO}$			V
VOL	Low-level output voltage				$0.1 \cdot V_{dd\_IO}$	V
Top	Operating temperature range		-40		+85	°C

1. Typical specifications are not guaranteed.

2. Sleep mode introduces a faster turn-on time compared to power-down mode.

## 2.3 Temperature sensor characteristics

The values given in the following table are for the conditions  $V_{dd} = 3.0\text{ V}$ ,  $T=25\text{ °C}$ , unless otherwise noted.

**Table 5. Temperature sensor characteristics <sup>(1)</sup>**

Symbol	Parameter	Test condition	Min.	Typ. <sup>(2)</sup>	Max.	Unit
TSDr	Temperature sensor output change vs. temperature	-		-1		°C/digit
TODR	Temperature refresh rate			1		Hz
Top	Operating temperature range		-40		+85	°C

1. The product is factory calibrated at 3.0 V.

2. Typical specifications are not guaranteed.

## 2.4 Communication interface characteristics

### 2.4.1 SPI - serial peripheral interface

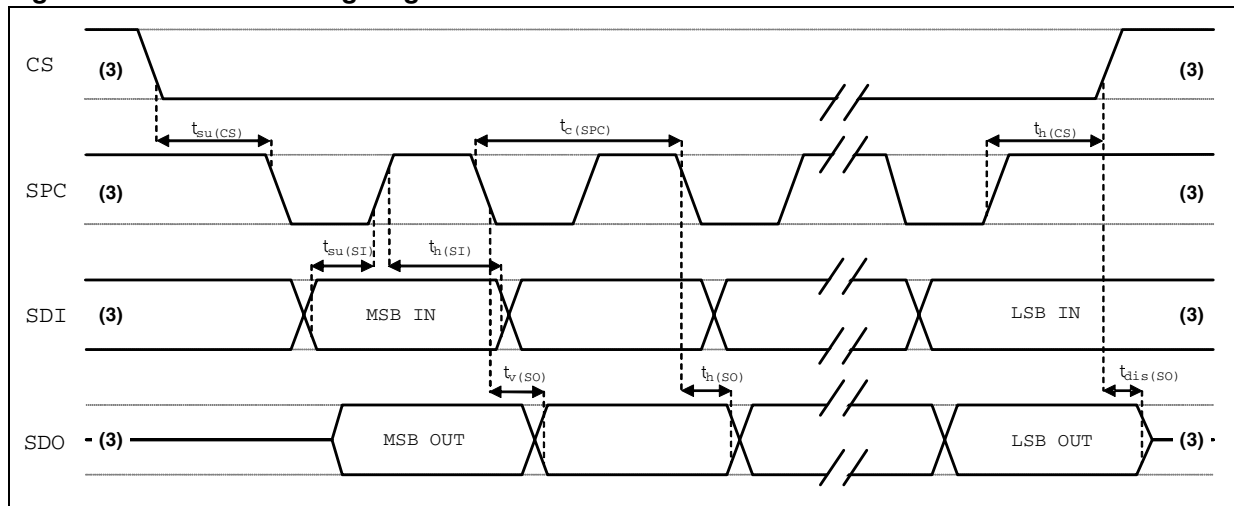
The values given in the following table are subject to the general operating conditions for  $V_{DD}$  and  $T_{OP}$

**Table 6. SPI slave timing values**

Symbol	Parameter	Value <sup>(1)</sup>		Unit
		Min	Max	
$t_{c(SPC)}$	SPI clock cycle	100		ns
$f_{c(SPC)}$	SPI clock frequency		10	MHz
$t_{su(CS)}$	CS setup time	6		ns
$t_h(CS)$	CS hold time	8		
$t_{su(SI)}$	SDI input setup time	5		
$t_h(SI)$	SDI input hold time	15		
$t_v(SO)$	SDO valid output time		50	
$t_h(SO)$	SDO output hold time	9		
$t_{dis(SO)}$	SDO output disable time		50	

1. Values are guaranteed at 10 MHz clock frequency for SPI with both 4 and 3 wires, based on characterization results, not tested in production.

**Figure 3. SPI slave timing diagram (b)**



3. Data on CS, SPC, SDI and SDO concern the following pins: CS\_A/G, SCL\_A/G, SDA/SDI\_A/G, SDO\_A/G

b. Measurement points are done at 0.2·V<sub>DD\_IO</sub> and 0.8·V<sub>DD\_IO</sub>, for both input and output ports.

### 2.4.2 I<sup>2</sup>C - inter-IC control interface

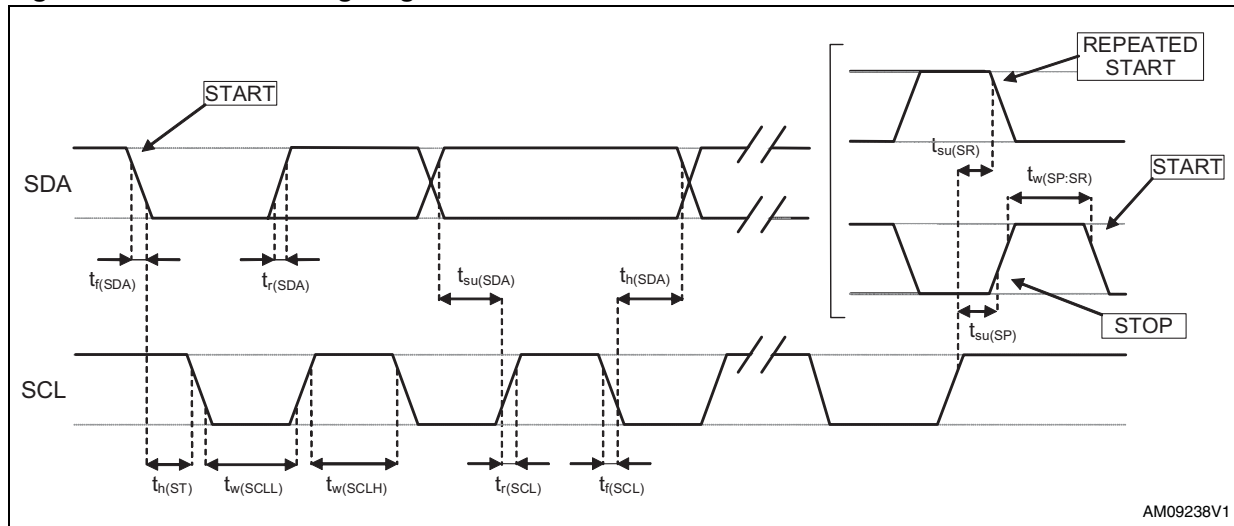
The values given in the following table are subject to the general operating conditions for V<sub>DD</sub> and T<sub>OP</sub>

**Table 7. I<sup>2</sup>C slave timing values**

Symbol	Parameter <sup>(1)</sup>	I <sup>2</sup> C standard mode		I <sup>2</sup> C fast mode <sup>(1)</sup>		Unit
		Min	Max	Min	Max	
f <sub>(SCL)</sub>	SCL clock frequency	0	100	0	400	kHz
t <sub>w(SCLL)</sub>	SCL clock low time	4.7		1.3		μs
t <sub>w(SCLH)</sub>	SCL clock high time	4.0		0.6		
t <sub>su(SDA)</sub>	SDA setup time	250		100		ns
t <sub>h(SDA)</sub>	SDA data hold time	0.01	3.45	0	0.9	μs
t <sub>r(SDA)</sub> t <sub>r(SCL)</sub>	SDA and SCL rise time		1000	20 + 0.1C <sub>b</sub> <sup>(2)</sup>	300	ns
t <sub>f(SDA)</sub> t <sub>f(SCL)</sub>	SDA and SCL fall time		300	20 + 0.1C <sub>b</sub> <sup>(2)</sup>	300	
t <sub>h(ST)</sub>	START condition hold time	4		0.6		μs
t <sub>su(SR)</sub>	Repeated START condition setup time	4.7		0.6		
t <sub>su(SP)</sub>	STOP condition setup time	4		0.6		
t <sub>w(SP:SR)</sub>	Bus free time between STOP and START condition	4.7		1.3		

1. SCL (SCL\_A/G pin), SDA (SDA\_A/G pin)

**Figure 4. I<sup>2</sup>C slave timing diagram <sup>(3)</sup>**



1. Data based on standard I<sup>2</sup>C protocol requirement, not tested in production.
- 2 C<sub>b</sub> = total capacitance of one bus line, in pF
3. Measurement points are done at 0.2·V<sub>DD\_IO</sub> and 0.8·V<sub>DD\_IO</sub>, for both ports.

## 2.5 Absolute maximum ratings

Stresses above those listed as “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**Table 8. Absolute maximum ratings**

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.3 to 4.8	V
Vdd_IO	I/O pins supply voltage	-0.3 to 4.8	V
Vin	Input voltage on any control pin (SCL_A/G, SDA/SDI_A/G, SDO_A/G, CS_A/G)	-0.3 to Vdd_IO +0.3	V
A <sub>POW</sub>	Acceleration (any axis, powered, Vdd = 3 V)	3000 g for 0.5 ms	
		10000 g for 0.1 ms	
A <sub>UNP</sub>	Acceleration (any axis, unpowered)	3000 g for 0.5 ms	
		10000 g for 0.1 ms	
T <sub>OP</sub>	Operating temperature range	-40 to +85	°C
T <sub>STG</sub>	Storage temperature range	-40 to +125	°C
ESD	Electrostatic discharge protection	2 (HBM)	kV

*Note:* Supply voltage on any pin should never exceed 4.8 V



This is a device sensitive to mechanical shock, improper handling can cause permanent damage to the part



This is an ESD-sensitive device, improper handling can cause permanent damage to the part



## 2.6 Terminology

### 2.6.1 Sensitivity

Linear acceleration sensitivity can be determined by applying 1  $g$  acceleration to the device. As the sensor can measure DC accelerations, this can be done easily by pointing the axis of interest towards the center of the Earth, noting the output value, rotating the sensor by 180 degrees (point to the sky) and then noting the output value again. By doing so,  $\pm 1 g$  acceleration is applied to the sensor. Subtracting the larger output value from the smaller one, and dividing the result by 2, leads to the actual sensitivity of the sensor. This value changes very little over temperature and also very little over time. The sensitivity tolerance describes the range of sensitivities of a large population of sensors.

Angular rate sensitivity describes the angular rate gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and also very little over time.

### 2.6.2 Zero level

Linear acceleration zero- $g$  level offset (TyOff) describes the deviation of an actual output signal from the ideal output signal if no acceleration is present. A sensor in a steady state on a horizontal surface will measure 0  $g$  on the X-axis and 0  $g$  on the Y-axis whereas the Z-axis will measure 1  $g$ . The output is ideally in the middle of the dynamic range of the sensor (content of OUT registers 00h, data expressed as 2's complement number). A deviation from the ideal value in this case is called zero- $g$  offset. Offset is to some extent a result of stress to the MEMS sensor and therefore the offset can slightly change after mounting the sensor onto a printed circuit board or exposing it to extensive mechanical stress. Offset changes little over temperature, see "Zero- $g$  level change vs. temperature" (refer to [Table 3](#)). The zero- $g$  level tolerance (TyOff) describes the standard deviation of the range of zero- $g$  levels of a population of sensors.

The angular rate zero-rate level describes the actual output value if there is no angular rate present. Zero-rate level of precise MEMS sensors is, to some extent, a result of stress to the sensor and therefore the zero-rate level can slightly change after mounting the sensor onto a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and also very little over time.

## 3 Functionality

The LSM330DL is a system-in-package featuring a 3D digital accelerometer and a 3D digital gyroscope.

The complete device includes specific sensing elements and two IC interfaces able to measure both the acceleration and angular rate applied to the module and to provide a signal to the external world through an SPI/I<sup>2</sup>C serial interface.

The various sensing elements are manufactured using specialized micromachining processes, while the IC interfaces are based on CMOS technology that allows designing a dedicated circuit which is trimmed to better match the sensing element characteristics.

The LSM330DL may also be configured to generate an inertial wake-up and free-fall interrupt signal according to a programmed acceleration event along the enabled axes.

### 3.1 Factory calibration

The IC interface is factory calibrated for sensitivity and zero level. The trimming values are stored inside the device in non-volatile memory. Any time the device is turned on, the trimming parameters are downloaded into the registers to be used during normal operation. This allows using the device without further calibration.

## 4 Application hints

Figure 5. LSM330DL electrical connections

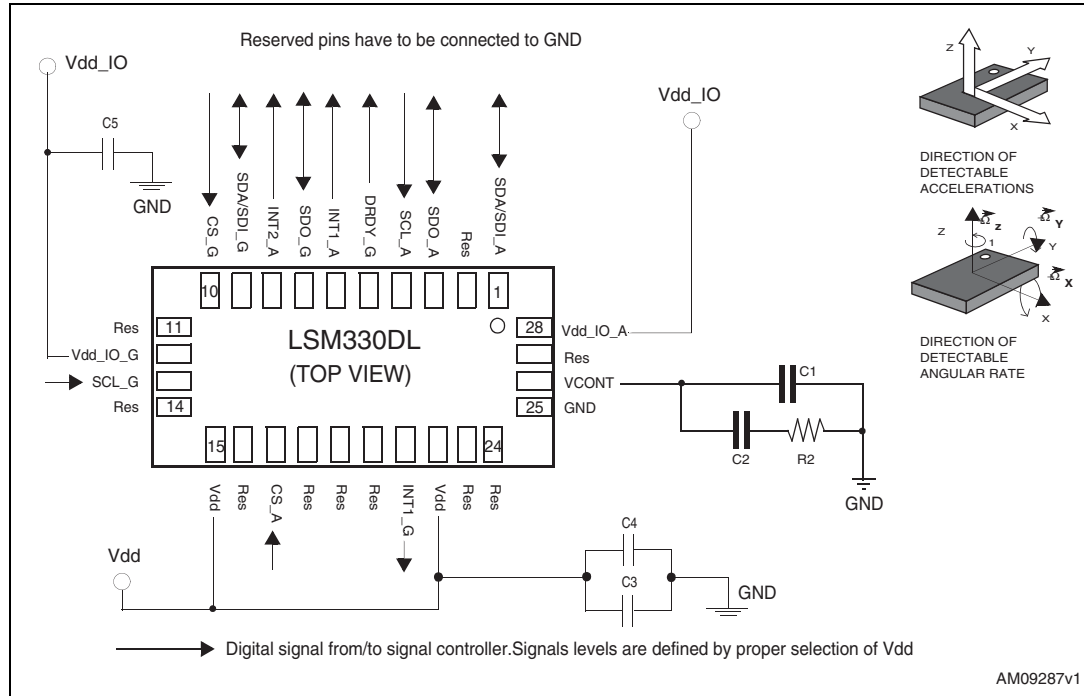


Table 9. Part list

Component	Typical value
C1	10 nF
C2	470 nF
C3	10 $\mu$ F
C4	100 nF
C5	
R2	10 kOhm

### 4.1 External capacitors

The device core is supplied through the Vdd line. Power supply decoupling capacitors (C4=100 nF ceramic, C3=10  $\mu$ F Al) should be placed as near as possible to the supply pin of the device (common design practice).

All the voltage and ground supplies must be present at the same time to have proper behavior of the IC (refer to [Figure 5](#)).

The functionality of the device and the measured acceleration/angular rate data is selectable and accessible through the SPI/I<sup>2</sup>C interface.

The functions, the threshold and the timing of the two interrupt pins for each sensor can be completely programmed by the user through the SPI/I<sup>2</sup>C interface.

## 4.2 Soldering information

The LGA package is compliant with the ECOPACK<sup>®</sup>, RoHS and “Green” standards. It is qualified for soldering heat resistance according to JEDEC J-STD-020D.

Leave “Pin 1 Indicator” unconnected during soldering.

The landing pattern and soldering recommendations are available at [www.st.com/mems](http://www.st.com/mems).

## 5 Digital interfaces

The registers embedded inside the LSM330DL may be accessed through both the I<sup>2</sup>C and SPI serial interfaces. The latter may be SW configured to operate either in 3-wire or 4-wire interface mode.

To select/exploit the I<sup>2</sup>C interface, the CS line must be tied high (i.e. connected to Vdd\_IO).

**Table 10. Serial interface pin description**

Pin name	Pin description
CS_A	Linear acceleration SPI enable Linear acceleration I <sup>2</sup> C/SPI mode selection (1: I <sup>2</sup> C mode; 0: SPI enabled)
CS_G	Angular rate SPI enable Angular rate I <sup>2</sup> C/SPI mode selection (1: I <sup>2</sup> C mode; 0: SPI enabled)
SCL_A SCL_G	I <sup>2</sup> C serial clock (SCL) SPI serial port clock (SPC)
SDA/SDI_A SDA/SDI_G	I <sup>2</sup> C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)
SDO_A SDO_G	I <sup>2</sup> C least significant bit of the device address (SA0) SPI serial data output (SDO)

### 5.1 I<sup>2</sup>C serial interface

The LSM330DL I<sup>2</sup>C is a bus slave. The I<sup>2</sup>C is employed to write data into the registers whose content can also be read back.

The relevant I<sup>2</sup>C terminology is given in the table below.

**Table 11. Serial interface terminology**

Term	Description
Transmitter	The device which sends data to the bus
Receiver	The device which receives data from the bus
Master	The device which initiates a transfer, generates clock signals and terminates a transfer
Slave	The device addressed by the master

There are two signals associated with the I<sup>2</sup>C bus: the serial clock line (SCL) and the serial data line (SDA). The latter is a bidirectional line used for sending and receiving the data to/from the interface.

### 5.1.1 I<sup>2</sup>C operation

The transaction on the bus is started through a START (ST) signal. A START condition is defined as a HIGH to LOW transition on the data line while the SCL line is held HIGH. After this has been transmitted by the Master, the bus is considered busy. The next byte of data transmitted after the start condition contains the address of the slave in the first 7 bits and the eighth bit tells whether the Master is receiving data from the slave or transmitting data to the slave. When an address is sent, each device in the system compares the first seven bits after a start condition with its own address. If they match, the device considers itself addressed by the Master.

Data transfer with acknowledge is mandatory. The transmitter must release the SDA line during the acknowledge pulse. The receiver must then pull the data line LOW so that it remains stable low during the HIGH period of the acknowledge clock pulse. A receiver which has been addressed is obliged to generate an acknowledge after each byte of data received.

The I<sup>2</sup>C embedded inside the LSM330DL behaves like a slave device and the following protocol must be adhered to. After the start condition (ST) a slave address is sent, once a slave acknowledge (SAK) has been returned, an 8-bit sub-address (SUB) will be transmitted: the 7 LSb represents the actual register address while the MSB enables the address auto increment. If the MSb of the SUB field is '1', the SUB (register address) will be automatically increased to allow multiple data read/writes.

**Table 12. Transfer when master is writing one byte to slave**

Master	ST	SAD + W		SUB		DATA		SP
Slave			SAK		SAK		SAK	

**Table 13. Transfer when master is writing multiple bytes to slave**

Master	ST	SAD + W		SUB		DATA		DATA		SP
Slave			SAK		SAK		SAK		SAK	

**Table 14. Transfer when master is receiving (reading) one byte of data from slave**

Master	ST	SAD + W		SUB		SR	SAD + R			NMAK	SP
Slave			SAK		SAK			SAK	DATA		

**Table 15. Transfer when master is receiving (reading) multiple bytes of data from slave**

Master	ST	SAD+W		SUB		SR	SAD+R		MAK		MAK		NMAK	SP
Slave			SAK		SAK			SAK	DATA		DATA		DATA	

Data are transmitted in byte format (DATA). Each data transfer contains 8 bits. The number of bytes transferred per transfer is unlimited. Data is transferred with the Most Significant bit (MSb) first. If a receiver can't receive another complete byte of data until it has performed some other function, it can hold the clock line, SCL LOW to force the transmitter into a wait

state. Data transfer only continues when the receiver is ready for another byte and releases the data line. If a slave receiver doesn't acknowledge the slave address (i.e. it is not able to receive because it is performing some real-time function), the data line must be left HIGH by the slave. The Master can then abort the transfer. A LOW to HIGH transition on the SDA line while the SCL line is HIGH is defined as a STOP condition. Each data transfer must be terminated by the generation of a STOP (SP) condition.

In order to read multiple bytes, it is necessary to assert the most significant bit of the sub-address field. In other words, SUB(7) must be equal to 1 while SUB(6-0) represents the address of first register to be read.

In the presented communication format MAK is Master acknowledge and NMAK is No Master Acknowledge.

#### Default address

The **SDO/SA0** pad can be used to modify the least significant bit of the device address. If the SA0 pad is connected to a voltage supply, LSb is '1' (ex. address 0011001b), else if the SA0 pad is connected to ground, the LSb value is '0' (ex address 0011000b).

The slave address is completed with a Read/Write bit. If the bit was '1' (Read), a repeated START (SR) condition will have to be issued after the two sub-address bytes. If the bit is '0' (Write), the Master will transmit to the slave with the direction unchanged. [Table 16](#) and [Table 17](#) explain how the SAD+Read/Write bit pattern is composed, listing all the possible configurations.

#### Linear acceleration address: the default (factory) 7-bit slave address is 001100xb

**Table 16. Linear acceleration SAD+Read/Write patterns**

Command	SAD[6:1]	SAD[0] = SA0	R/W	SAD+R/W
Read	001100	0	1	00110001 (31h)
Write	001100	0	0	00110000 (30h)
Read	001100	1	1	00110011 (33h)
Write	001100	1	0	00110010 (32h)

#### Angular rate sensor: the default (factory) 7-bit slave address is 110100xb

**Table 17. Angular rate SAD+Read/Write patterns**

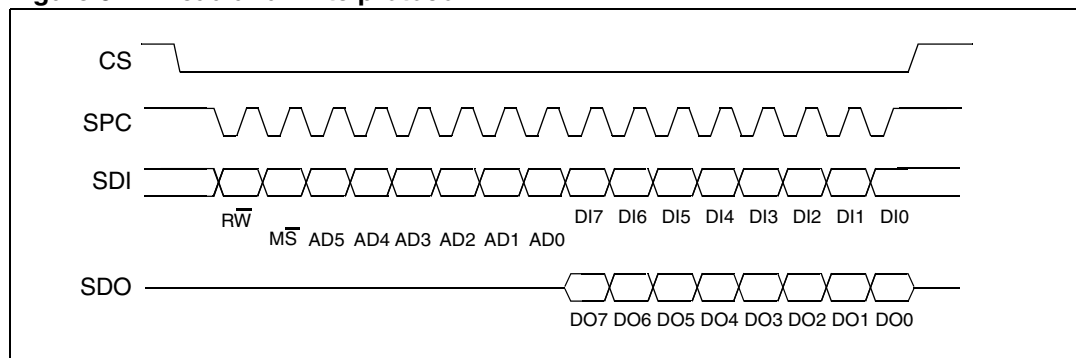
Command	SAD[6:1]	SAD[0] = SA0	R/W	SAD+R/W
Read	110100	0	1	11010001 (D1h)
Write	110100	0	0	11010000 (D0h)
Read	110100	1	1	11010011 (D3h)
Write	110100	1	0	11010010 (D2h)

## 5.2 SPI bus interface

The LSM330DL SPI is a bus slave. The SPI allows to write and read the registers of the device.

The Serial Interface interacts with the outside world with 4 wires: **CS**, **SPC**, **SDI** and **SDO** (SPC, SDI, SDO are common).

**Figure 6. Read and write protocol**



**CS** is the serial port enable and it is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. **SPC** is the serial port clock and it is controlled by the SPI master. It is stopped high when **CS** is high (no transmission). **SDI** and **SDO** are, respectively, the serial port data input and output. These lines are driven at the falling edge of **SPC** and should be captured at the rising edge of **SPC**.

Both the read register and write register commands are completed in 16 clock pulses or in multiples of 8 in case of multiple read/write bytes. Bit duration is the time between two falling edges of **SPC**. The first bit (bit 0) starts at the first falling edge of **SPC** after the falling edge of **CS**, while the last bit (bit 15, bit 23, ...) starts at the last falling edge of **SPC** just before the rising edge of **CS**.

**bit 0:**  $\overline{RW}$  bit. When 0, the data  $DI(7:0)$  is written into the device. When 1, the data  $DO(7:0)$  from the device is read. In the latter case, the chip will drive **SDO** at the start of bit 8.

**bit 1:**  $\overline{MS}$  bit. When 0, the address will remain unchanged in multiple read/write commands. When 1, the address will be auto-incremented in multiple read/write commands.

**bit 2-7:** address  $AD(5:0)$ . This is the address field of the indexed register.

**bit 8-15:** data  $DI(7:0)$  (write mode). This is the data that will be written into the device (MSb first).

**bit 8-15:** data  $DO(7:0)$  (read mode). This is the data that will be read from the device (MSb first).

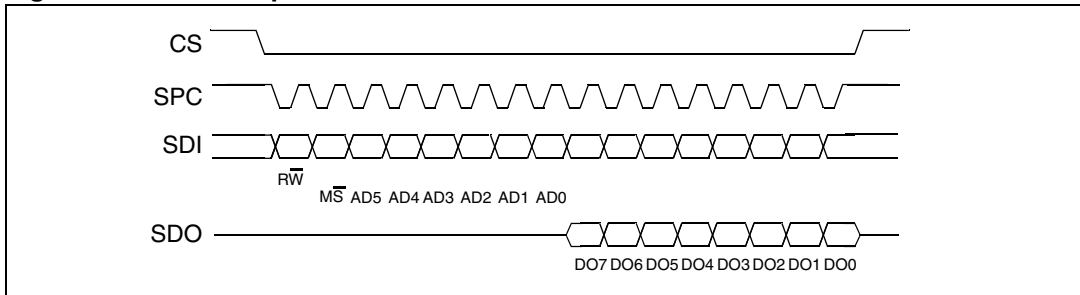
In multiple read/write commands, further blocks of 8 clock periods will be added. When the  $\overline{MS}$  bit is '0', the address used to read/write data remains the same for every block. When the  $\overline{MS}$  bit is '1', the address used to read/write data is increased at every block.

The function and the behavior of **SDI** and **SDO** remain unchanged.



### 5.2.1 SPI read

**Figure 7. SPI read protocol**



The SPI Read command is performed with 16 clock pulses. The multiple byte read command is performed, adding blocks of 8 clock pulses to the previous one.

**bit 0:** READ bit. The value is 1.

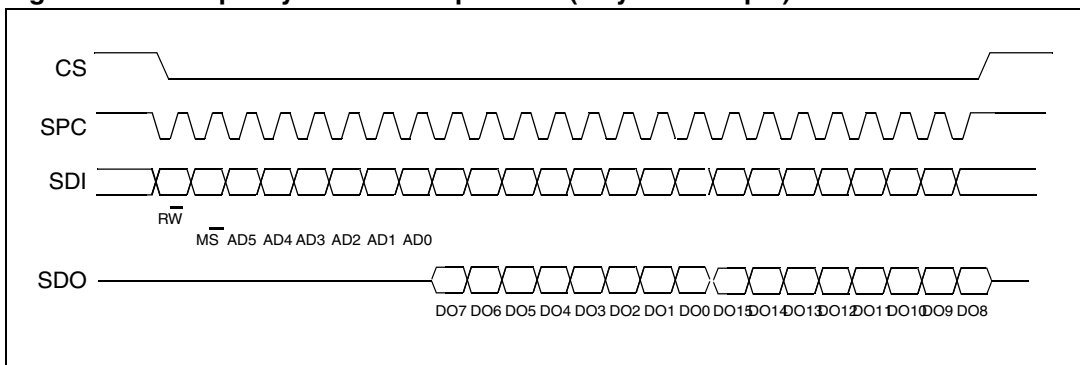
**bit 1:**  $\overline{MS}$  bit. When 0, this bit does not increment the address. When 1, it increments the address in multiple reads.

**bit 2-7:** address AD(5:0). This is the address field of the indexed register.

**bit 8-15:** data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

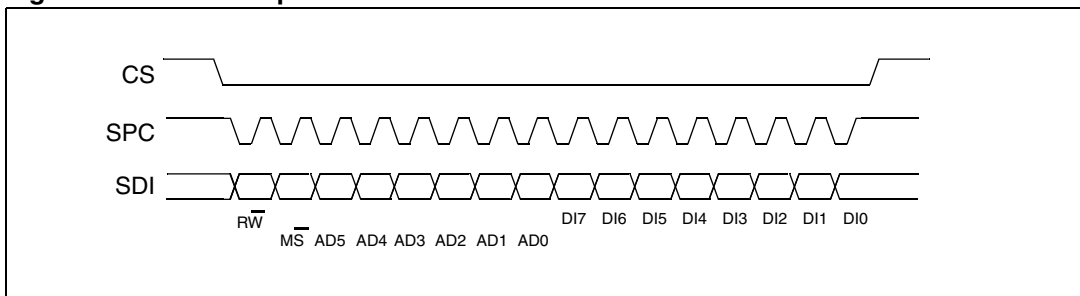
**bit 16-...** : data DO(...-8). Further data in multiple byte reads.

**Figure 8. Multiple bytes SPI read protocol (2 bytes example)**



### 5.2.2 SPI write

**Figure 9. SPI write protocol**



The SPI Write command is performed with 16 clock pulses. The multiple byte write command is performed adding blocks of 8 clock pulses to the previous one.

**bit 0:** WRITE bit. The value is 0.

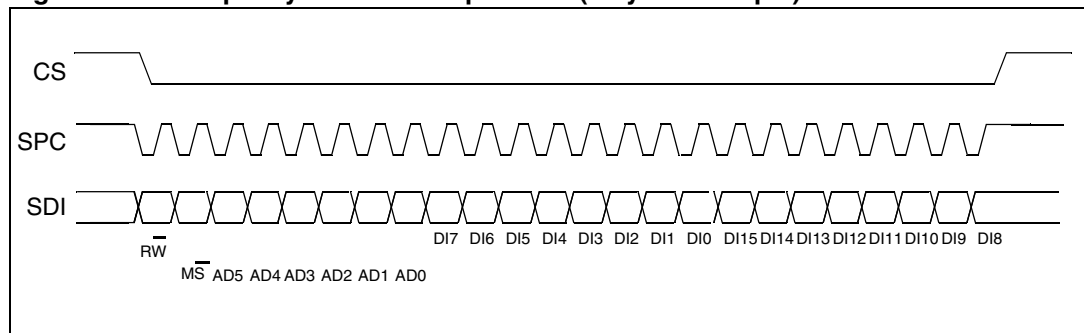
**bit 1:**  $\overline{MS}$  bit. When 0, this bit does not increment the address, when 1, it increments the address in multiple writes.

**bit 2 -7:** address AD(5:0). This is the address field of the indexed register.

**bit 8-15:** data DI(7:0) (write mode). This is the data that will be written inside the device (MSb first).

**bit 16-...** : data DI(...-8). Further data in multiple byte writes.

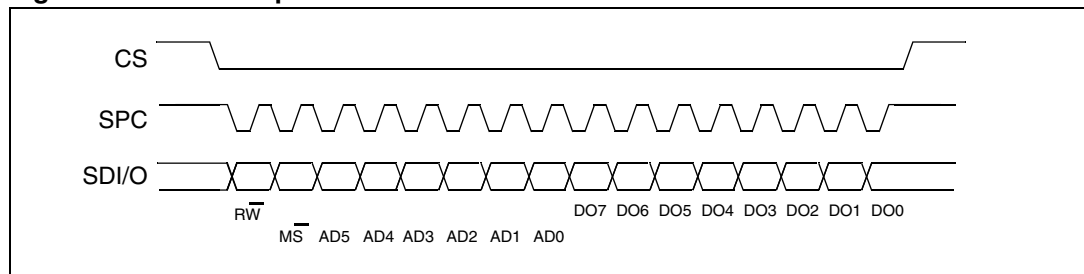
**Figure 10. Multiple bytes SPI write protocol (2 bytes example)**



### 5.2.3 SPI read in 3-wire mode

The 3-wire mode is entered by setting to '1' bit SIM (SPI serial interface mode selection) in CTRL\_REG4.

**Figure 11. SPI read protocol in 3-wire mode**



The SPI read command is performed with 16 clock pulses:

**bit 0:** READ bit. The value is 1.

**bit 1:**  $\overline{MS}$  bit. When 0, this bit does not increment the address, when 1, it increments the address in multiple reads.

**bit 2-7:** address AD(5:0). This is the address field of the indexed register.

**bit 8-15:** data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

The multiple read command is also available in 3-wire mode.

## 6 Register mapping

The table given below provides a listing of the 8-bit registers embedded in the device and their respective addresses.

**Table 18. Register address map**

Name	Slave address	Type	Register address		Default	Comment
			Hex	Binary		
Reserved (do not modify)	001100xb		00 - 1F			Reserved
CTRL_REG1_A	001100xb	rw	20	010 0000	00000111	
CTRL_REG2_A	001100xb	rw	21	010 0001	00000000	
CTRL_REG3_A	001100xb	rw	22	010 0010	00000000	
CTRL_REG4_A	001100xb	rw	23	010 0011	00000000	
CTRL_REG5_A	001100xb	rw	24	010 0100	00000000	
CTRL_REG6_A	001100xb	rw	25	010 0101	00000000	
REFERENCE/DATACAPTURE_A	001100xb	rw	26	010 0110	00000000	
STATUS_REG_A	001100xb	r	27	010 0111	00000000	
OUT_X_L_A	001100xb	r	28	010 1000	output	
OUT_X_H_A	001100xb	r	29	010 1001	output	
OUT_Y_L_A	001100xb	r	2A	010 1010	output	
OUT_Y_H_A	001100xb	r	2B	010 1011	output	
OUT_Z_L_A	001100xb	r	2C	010 1100	output	
OUT_Z_H_A	001100xb	r	2D	010 1101	output	
FIFO_CTRL_REG_A	001100xb	rw	2E	010 1110	00000000	
FIFO_SRC_REG_A	001100xb	r	2F	010 1111		
INT1_CFG_A	001100xb	rw	30	011 0000	00000000	
INT1_SRC_A	001100xb	r	31	011 0001	00000000	
INT1_THS_A	001100xb	rw	32	011 0010	00000000	
INT1_DURATION_A	001100xb	rw	33	011 0011	00000000	
INT2_CFG_A	001100xb	rw	34	011 0100	00000000	
INT2_SOURCE_A	001100xb	r	35	011 0101	00000000	
INT2_THS_A	001100xb	rw	36	011 0110	00000000	
INT2_DURATION_A	001100xb	rw	37	011 0111	00000000	
CLICK_CFG_A	001100xb	rw	38	011 1000	00000000	
CLICK_SRC_A	001100xb	rw	39	011 1001	00000000	
CLICK_THS_A	001100xb	rw	3A	011 1010	00000000	
TIME_LIMIT_A	001100xb	rw	3B	011 1011	00000000	

Table 18. Register address map (continued)

Name	Slave address	Type	Register address		Default	Comment
			Hex	Binary		
TIME_LATENCY_A	001100xb	rw	3C	011 1100	00000000	
TIME_WINDOW_A	001100xb	rw	3D	011 1101	00000000	
Reserved (do not modify)	001100xb		3E-3F			Reserved
Reserved	110100xb	-	00-1E	-	-	Reserved
CTRL_REG1_G	110100xb	rw	20	010 0000	00000111	
CTRL_REG2_G	110100xb	rw	21	010 0001	00000000	
CTRL_REG3_G	110100xb	rw	22	010 0010	00000000	
CTRL_REG4_G	110100xb	rw	23	010 0011	00000000	
CTRL_REG5_G	110100xb	rw	24	010 0100	00000000	
REFERENCE/DATACAPTURE_G	110100xb	rw	25	010 0101	00000000	
OUT_TEMP_G	110100xb	r	26	010 0110	output	
STATUS_REG_G	110100xb	r	27	010 0111	output	
OUT_X_L_G	110100xb	r	28	010 1000	output	
OUT_X_H_G	110100xb	r	29	010 1001	output	
OUT_Y_L_G	110100xb	r	2A	010 1010	output	
OUT_Y_H_G	110100xb	r	2B	010 1011	output	
OUT_Z_L_G	110100xb	r	2C	010 1100	output	
OUT_Z_H_G	110100xb	r	2D	010 1101	output	
FIFO_CTRL_REG_G	110100xb	rw	2E	010 1110	00000000	
FIFO_SRC_REG_G	110100xb	r	2F	010 1111	output	
INT1_CFG_G	110100xb	rw	30	011 0000	00000000	
INT1_SRC_G	110100xb	r	31	011 0001	output	
INT1_THS_XH_G	110100xb	rw	32	011 0010	00000000	
INT1_THS_XL_G	110100xb	rw	33	011 0011	00000000	
INT1_THS_YH_G	110100xb	rw	34	011 0100	00000000	
INT1_THS_YL_G	110100xb	rw	35	011 0101	00000000	
INT1_THS_ZH_G	110100xb	rw	36	011 0110	00000000	
INT1_THS_ZL_G	110100xb	rw	37	011 0111	00000000	
INT1_DURATION_G	110100xb	rw	38	011 1000	00000000	

Registers marked as *Reserved* must not be changed. Writing to those registers may cause permanent damage to the device.

The content of the registers that are loaded at boot should not be changed. They contain the factory-calibrated values. Their content is automatically restored when the device is powered up.

## 7 Registers description

The device contains a set of registers which are used to control its behavior and to retrieve acceleration, angular rate and temperature data. The register addresses, composed of 7 bits, are used to identify them and to write the data through the serial interface.

### 7.1 CTRL\_REG1\_A (20h)

**Table 19. CTRL\_REG1\_A register**

ODR3	ODR2	ODR1	ODR0	LPen	Zen	Yen	Xen
------	------	------	------	------	-----	-----	-----

**Table 20. CTRL\_REG1\_A description**

ODR3-0	Data rate selection. Default value: 0 (0000: power-down; Others: Refer to <a href="#">Table 21: Data rate configuration</a> )
LPen	Low-power mode enable. Default value: 0 (0: normal mode, 1: low-power mode)
Zen	Z-axis enable. Default value: 1 (0: Z-axis disabled; 1: Z-axis enabled)
Yen	Y-axis enable. Default value: 1 (0: Y-axis disabled; 1: Y-axis enabled)
Xen	X-axis enable. Default value: 1 (0: X-axis disabled; 1: X-axis enabled)

**ODR<3:0>** is used to set power mode and ODR selection. The following table gives the frequency for all combinations of ODR<3:0>.

**Table 21. Data rate configuration**

ODR3	ODR2	ODR1	ODR0	Power mode selection
0	0	0	0	Power-down mode
0	0	0	1	Normal / low-power mode (1 Hz)
0	0	1	0	Normal / low-power mode (10 Hz)
0	0	1	1	Normal / low-power mode (25 Hz)
0	1	0	0	Normal / low-power mode (50 Hz)
0	1	0	1	Normal / low-power mode (100 Hz)
0	1	1	0	Normal / low-power mode (200 Hz)
0	1	1	1	Normal / low-power mode (400 Hz)
1	0	0	0	Low-power mode (1.620 kHz)
1	0	0	1	Normal (1.344 kHz) / low-power mode (5.376 kHz)

**Table 22. Operating mode selection**

Operating mode	CTRL_REG1[3] (LPen bit)	CTRL_REG4[3] (HR bit)	BW [Hz]	Turn-on time [ms]
Low-power mode	1	0	ODR/2	1
Normal mode	0	1	ODR/9	7/ODR

## 7.2 CTRL\_REG2\_A (21h)

**Table 23. CTRL\_REG2\_A register**

HPM1	HPM0	HPCF2	HPCF1	FDS	HPCLICK	HPIS2	HPIS1
------	------	-------	-------	-----	---------	-------	-------

**Table 24. CTRL\_REG2\_A description**

HPM1 -HPM0	High-pass filter mode selection. Default value: 00 Refer to <a href="#">Table 25: High-pass filter mode configuration</a>
HPCF2 - HPCF1	High-pass filter cutoff frequency selection
FDS	Filtered data selection. Default value: 0 (0: internal filter bypassed; 1: data from internal filter sent to output register and FIFO)
HPCLICK	High-pass filter enabled for CLICK function (0: filter bypassed; 1: filter enabled)
HPIS2	High-pass filter enabled for AOI function on interrupt 2, (0: filter bypassed; 1: filter enabled)
HPIS1	High-pass filter enabled for AOI function on interrupt 1, (0: filter bypassed; 1: filter enabled)

**Table 25. High-pass filter mode configuration**

HPM1	HPM0	High-pass filter mode
0	0	Normal mode (reset reading HP_RESET_FILTER)
0	1	Reference signal for filtering
1	0	Normal mode
1	1	Autoreset on interrupt event

### 7.3 CTRL\_REG3\_A (22h)

**Table 26. CTRL\_REG3\_A register**

I1_CLICK	I1_AOI1	0 <sup>(1)</sup>	I1_DRDY1	I1_DRDY2	I1_WTM	I1_OVERRUN	--
----------	---------	------------------	----------	----------	--------	------------	----

1. This bit has to be set '0' for correct operation.

**Table 27. CTRL\_REG3\_A description**

I1_CLICK	CLICK interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)
I1_AOI1	AOI1 interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)
I1_DRDY1	DRDY1 interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)
I1_DRDY2	DRDY2 interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)
I1_WTM	FIFO watermark interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)
I1_OVERRUN	FIFO overrun interrupt on INT1_A. Default value 0. (0: Disable; 1: Enable)

### 7.4 CTRL\_REG4\_A (23h)

**Table 28. CTRL\_REG4\_A register**

BDU	BLE	FS1	FS0	HR	0 <sup>(1)</sup>	0 <sup>(1)</sup>	SIM
-----	-----	-----	-----	----	------------------	------------------	-----

**Table 29. CTRL\_REG4\_A description**

BDU	Block data update. Default value: 0(0: continuous update; 1: output registers not updated until MSB and LSB reading)
BLE	Big/little endian data selection. Default value 0. (0: Data LSB at lower address; 1: Data MSB at lower address)
FS1-FS0	Full-scale selection. default value: 00 (00: +/- 2G; 01: +/- 4G; 10: +/- 8G; 11: +/- 16G)
HR	Normal mode: default value: 0 (0: normal mode disable; 1: normal mode enable)
SIM	SPI serial interface mode selection. Default value: 0 (0: 4-wire interface; 1: 3-wire interface)

## 7.5 CTRL\_REG5\_A (24h)

**Table 30. CTRL\_REG5\_A register**

BOOT	FIFO_EN	--	--	LIR_INT1	D4D_INT1	0 <sup>(1)</sup>	0 <sup>(1)</sup>
------	---------	----	----	----------	----------	------------------	------------------

1. This bit has to be set '0' for correct operation.

**Table 31. CTRL\_REG5\_A description**

BOOT	Reboot memory content. Default value: 0 (0: normal mode; 1: reboot memory content)
FIFO_EN	FIFO enable. Default value: 0 (0: FIFO disable; 1: FIFO enable)
LIR_INT1	Latch interrupt request on INT1_SRC_A register, with INT1_SRC_A register cleared by reading INT1_SRC_A itself. Default value: 0. (0: interrupt request not latched; 1: interrupt request latched)
D4D_INT1	4D enable: 4D detection is enabled on INT1_A when 6D bit on INT1_CFG_A is set to 1.

## 7.6 CTRL\_REG6\_A (25h)

**Table 32. CTRL\_REG6\_A register**

I2_CLICKen	I2_INT1	0 <sup>(1)</sup>	BOOT_I2	0 <sup>(1)</sup>	--	H_LACTIVE	--
------------	---------	------------------	---------	------------------	----	-----------	----

1. This bit has to be set to '0' for correct operation.

**Table 33. CTRL\_REG6 description**

I2_CLICKen	Click interrupt on INT2_A. Default value 0.
I2_INT1	Interrupt 1 function enabled on INT2_A. Default 0.
BOOT_I2	Boot on INT2_A.
H_LACTIVE	0: interrupt active high; 1: interrupt active low.

## 7.7 REFERENCE/DATACAPTURE\_A (26h)

**Table 34. REFERENCE/DATACAPTURE\_A register**

Ref7	Ref6	Ref5	Ref4	Ref3	Ref2	Ref1	Ref0
------	------	------	------	------	------	------	------

**Table 35. REFERENCE/DATACAPTURE\_A register description**

Ref 7-Ref0	Reference value for interrupt generation. Default value: 0
------------	--



## 7.8 STATUS\_REG\_A (27h)

**Table 36. STATUS\_REG\_A register**

ZYXOR	ZOR	YOR	XOR	ZYXDA	ZDA	YDA	XDA
-------	-----	-----	-----	-------	-----	-----	-----

**Table 37. STATUS\_REG\_A register description**

ZYXOR	X-, Y- and Z-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: a new set of data has overwritten the previous ones)
ZOR	Z-axis data overwrite. Default value: 0 (0: no overrun has occurred; 1: a new data for the Z-axis has overwritten the previous one)
YOR	Y-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data for the Y-axis has overwritten the previous data)
XOR	X-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data for the X-axis has overwritten the previous data)
ZYXDA	X-, Y- and Z-axis new data available. Default value: 0 (0: a new set of data is not yet available; 1: a new set of data is available)
ZDA	Z-axis new data available. Default value: 0 (0: new data for the Z-axis is not yet available; 1: new data for the Z-axis is available)
YDA	Y-axis new data available. Default value: 0 (0: new data for the Y-axis is not yet available; 1: new data for the Y-axis is available)

## 7.9 OUT\_X\_L\_A (28h), OUT\_X\_H\_A (29h)

This register contains X-axis acceleration data. Values are expressed in two's complement.

## 7.10 OUT\_Y\_L\_A (2Ah), OUT\_Y\_H\_A (2Bh)

This register contains Y-axis acceleration data. Values are expressed in two's complement.

## 7.11 OUT\_Z\_L\_A (2Ch), OUT\_Z\_H\_A (2Dh)

This register contains Z-axis acceleration data. Values are expressed in two's complement.

## 7.12 FIFO\_CTRL\_REG\_A (2Eh)

**Table 38. FIFO\_CTRL\_REG\_A register**

FM1	FM0	TR	FTH4	FTH3	FTH2	FTH1	FTH0
-----	-----	----	------	------	------	------	------

**Table 39. FIFO\_CTRL\_REG\_A register description**

FM1-FM0	FIFO mode selection. Default value: 00 (see <a href="#">Table 40: FIFO mode configuration</a> )
TR	Trigger selection. Default value: 0 0: Trigger event linked to trigger signal on INT1_A 1: Trigger event linked to trigger signal on INT2_A
FTH4:0	Default value: 0

**Table 40. FIFO mode configuration**

FM1	FM0	FIFO mode
0	0	Bypass mode
0	1	FIFO mode
1	0	Stream mode
1	1	Trigger mode

### 7.13 FIFO\_SRC\_REG\_A (2Fh)

**Table 41. FIFO\_SRC\_REG\_A register**

WTM	OVNR_FIFO	EMPTY	FSS4	FSS3	FSS2	FSS1	FSS0
-----	-----------	-------	------	------	------	------	------

### 7.14 INT1\_CFG\_A (30h)

**Table 42. INT1\_CFG\_REG\_A register**

AOI	6D	ZHIE/ ZUPE	ZLIE/ ZDOWNE	YHIE/ YUPE	YLIE/ YDOWNE	XHIE/ XUPE	XLIE/ XDOWNE
-----	----	---------------	-----------------	---------------	-----------------	---------------	-----------------

**Table 43. INT1\_CFG\_REG\_A description**

AOI	And/Or combination of Interrupt events. Default value: 0. Refer to <a href="#">Table 44: Interrupt mode</a>
6D	6-direction detection function enabled. Default value: 0. Refer to <a href="#">Table 44: Interrupt mode</a>
ZHIE/ ZUPE	Enable interrupt generation on Z high event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request)
ZLIE/ ZDOWNE	Enable interrupt generation on Z low event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request)
YHIE/ YUPE	Enable interrupt generation on Y high event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request.)
YLIE/ YDOWNE	Enable interrupt generation on Y low event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request.)

**Table 43. INT1\_CFG\_REG\_A description (continued)**

XHIE/ XUPE	Enable interrupt generation on X high event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request.)
XLIE/XDO WNE	Enable interrupt generation on X low event or on direction recognition. Default value: 0 (0: disable interrupt request; 1: enable interrupt request.)

The contents of the INT1\_CFG\_REG\_A register are loaded at boot.

A write operation at this address is possible only after system boot.

**Table 44. Interrupt mode**

AOI	6D	Interrupt mode
0	0	OR combination of interrupt events
0	1	6-direction movement recognition
1	0	AND combination of interrupt events
1	1	6-direction position recognition

The difference between AOI-6D = '01' and AOI-6D = '11' is defined as follows:

AOI-6D = '01' is movement recognition. An interrupt is generated when the orientation moves from an unknown zone to a known zone. The interrupt signal stays for a duration determined by ODR.

AOI-6D = '11' is direction recognition. An interrupt is generated when the orientation is inside a known zone. The interrupt signal stays until orientation is inside the zone.

## 7.15 INT1\_SRC\_A (31h)

**Table 45. INT1\_SRC\_A register**

0 <sup>(1)</sup>	IA	ZH	ZL	YH	YL	XH	XL
------------------	----	----	----	----	----	----	----

1. This bit has to be set to '0' for correct operation.

**Table 46. INT1\_SRC\_A description**

IA	Interrupt active. Default value: 0 (0: no interrupt has been generated; 1: one or more interrupts have been generated)
ZH	Z high. Default value: 0 (0: no interrupt, 1: Z high event has occurred)
ZL	Z low. Default value: 0 (0: no interrupt; 1: Z low event has occurred)
YH	Y high. Default value: 0 (0: no interrupt, 1: Y high event has occurred)
YL	Y low. Default value: 0 (0: no interrupt, 1: Y low event has occurred)

**Table 46. INT1\_SRC\_A description**

XH	X high. Default value: 0 (0: no interrupt, 1: X high event has occurred)
XL	X low. Default value: 0 (0: no interrupt, 1: X low event has occurred)

The Interrupt 1 source register is a read-only register.

Reading at this address clears the INT1\_SRC\_A IA bit (and the interrupt signal on the INT1\_A pin) and allows the refreshment of data in the INT1\_SRC\_A register if the latched option was chosen.

## 7.16 INT1\_THS\_A (32h)

**Table 47. INT1\_THS\_A register**

0 <sup>(1)</sup>	THS6	THS5	THS4	THS3	THS2	THS1	THS0
------------------	------	------	------	------	------	------	------

1. This bit has to be set to '0' for correct operation.

**Table 48. INT1\_THS\_A description**

THS6 - THS0	Interrupt 1 threshold. Default value: 000 0000
-------------	--

## 7.17 INT1\_DURATION\_A (33h)

**Table 49. INT1\_DURATION\_A register**

0 <sup>(1)</sup>	D6	D5	D4	D3	D2	D1	D0
------------------	----	----	----	----	----	----	----

1. This bit has to be set to '0' for correct operation.

**Table 50. INT1\_DURATION\_A description**

D6 - D0	Duration value. Default value: 000 0000
---------	---

The D6 - D0 bits set the minimum duration of the Interrupt 1 event to be recognized. The duration of the steps and maximum values depend on the ODR chosen.

## 7.18 CLICK\_CFG\_A (38h)

**Table 51. CLICK\_CFG\_A register**

--	--	ZD	ZS	YD	YS	XD	XS
----	----	----	----	----	----	----	----

**Table 52. CLICK\_CFG\_A description**

ZD	Enable interrupt double CLICK on Z-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
ZS	Enable interrupt single CLICK on Z-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
YD	Enable interrupt double CLICK on Y-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
YS	Enable interrupt single CLICK on Y-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
XD	Enable interrupt double CLICK on X-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
XS	Enable interrupt single CLICK on X-axis. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)

## 7.19 CLICK\_SRC\_A (39h)

**Table 53. CLICK\_SRC\_A register**

--	IA	DCLICK	SCLICK	Sign	Z	Y	X
----	----	--------	--------	------	---	---	---

**Table 54. CLICK\_SRC\_A description**

IA	Interrupt active. Default value: 0 (0: no interrupt has been generated; 1: one or more interrupts have been generated)
DCLICK	Double CLICK-CLICK enable. Default value: 0 (0: double CLICK-CLICK detection disable, 1: double CLICK-CLICK detection enable)
SCLICK	Single CLICK-CLICK enable. Default value: 0 (0: single CLICK-CLICK detection disable, 1: single CLICK-CLICK detection enable)
Sign	CLICK-CLICK Sign. 0: positive detection, 1: negative detection
Z	Z CLICK-CLICK detection. Default value: 0 (0: no interrupt, 1: Z high event has occurred)
Y	Y CLICK-CLICK detection. Default value: 0 (0: no interrupt, 1: Y high event has occurred)
X	X CLICK-CLICK detection. Default value: 0 (0: no interrupt, 1: X high event has occurred)

## 7.20 CLICK\_THS\_A (3Ah)

**Table 55. CLICK\_THS\_A register**

LIR	Ths6	Ths5	Ths4	Ths3	Ths2	Ths1	Ths0
-----	------	------	------	------	------	------	------

**Table 56. CLICK\_SRC\_A description**

Ths6-Ths0	CLICK-CLICK threshold. Default value: 000 0000
LIR	Latch interrupt request for CLICK-CLICK function enable. 0 disable, 1 enable

## 7.21 TIME\_LIMIT\_A (3Bh)

**Table 57. TIME\_LIMIT\_A register**

--	TLI6	TLI5	TLI4	TLI3	TLI2	TLI1	TLI0
----	------	------	------	------	------	------	------

**Table 58. TIME\_LIMIT\_A description**

TLI7-TLI0	CLICK-CLICK time limit. Default value: 000 0000
-----------	---

## 7.22 TIME\_LATENCY\_A (3Ch)

**Table 59. TIME\_LATENCY\_A register**

TLA7	TLA6	TLA5	TLA4	TLA3	TLA2	TLA1	TLA0
------	------	------	------	------	------	------	------

**Table 60. TIME\_LATENCY\_A description**

TLA7-TLA0	CLICK-CLICK time latency. Default value: 000 0000
-----------	---

## 7.23 TIME\_WINDOW\_A (3Dh)

**Table 61. TIME\_WINDOW\_A register**

TW7	TW6	TW5	TW4	TW3	TW2	TW1	TW0
-----	-----	-----	-----	-----	-----	-----	-----

**Table 62. TIME\_WINDOW\_A description**

TW7-TW0	CLICK-CLICK time window
---------	-------------------------

## 7.24 CTRL\_REG1\_G (20h)

**Table 63. CTRL\_REG1\_G register**

DR1	DR0	BW1	BW0	PD	Zen	Yen	Xen
-----	-----	-----	-----	----	-----	-----	-----

**Table 64. CTRL\_REG1\_G description**

DR1-DR0	Output data rate selection. Refer to <a href="#">Table 65: DR and BW configuration setting</a>
BW1-BW0	Bandwidth selection. Refer to <a href="#">Table 65: DR and BW configuration setting</a>
PD	Power-down mode enable. Default value: 0 (0: power-down mode, 1: normal mode or sleep mode)
Zen	Z-axis enable. Default value: 1 (0: Z-axis disabled; 1: Z-axis enabled)
Yen	Y-axis enable. Default value: 1 (0: Y-axis disabled; 1: Y-axis enabled)
Xen	X-axis enable. Default value: 1 (0: X-axis disabled; 1: X-axis enabled)

**DR<1:0>** is used to set the ODR selection. **BW <1:0>** is used to set bandwidth selection.

The following table gives the frequencies for all combinations of the DR / BW bits.

**Table 65. DR and BW configuration setting**

DR <1:0>	BW <1:0>	ODR [Hz]	cutoff [Hz]
00	00	100	12.5
00	01	100	25
00	10	100	25
00	11	100	25
01	00	200	12.5
01	01	200	25
01	10	200	50
01	11	200	70
10	00	400	20
10	01	400	25
10	10	400	50
10	11	400	110
11	00	800	30
11	01	800	35
11	10	800	50
11	11	800	110

Combination of **PD**, **Zen**, **Yen**, **Xen** are used to set device in different modes (power-down / normal / sleep mode) according to the following table.

**Table 66. Power mode selection configuration**

Mode	PD	Zen	Yen	Xen
Power-down	0	-	-	-
Sleep	1	0	0	0
Normal	1	-	-	-

## 7.25 CTRL\_REG2\_G (21h)

**Table 67. CTRL\_REG2\_G register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	HPM1	HPM0	HPCF3	HPCF2	HPCF1	HPCF0
------------------	------------------	------	------	-------	-------	-------	-------

1. This bit has to be set to '0' for correct operation.

**Table 68. CTRL\_REG2\_G description**

HPM1-HPM0	High-pass filter mode selection. Default value: 00 Refer to <a href="#">Table 69: High-pass filter mode configuration</a>
HPCF3-HPCF0	High-pass filter cutoff frequency selection Refer to <a href="#">Table 70: High-pass filter cutoff frequency configuration [Hz]</a>

**Table 69. High-pass filter mode configuration**

HPM1	HPM0	High-pass filter mode
0	0	Normal mode (reset reading HP_RESET_FILTER)
0	1	Reference signal for filtering
1	0	Normal mode
1	1	Autoreset on interrupt event

**Table 70. High-pass filter cutoff frequency configuration [Hz]**

HPCF3-0	ODR = 100 Hz	ODR = 200 Hz	ODR = 400 Hz	ODR = 800 Hz
0000	8	15	30	56
0001	4	8	15	30
0010	2	4	8	15
0011	1	2	4	8
0100	0.5	1	2	4
0101	0.2	0.5	1	2



**Table 70. High-pass filter cutoff frequency configuration [Hz] (continued)**

HPCF3-0	ODR = 100 Hz	ODR = 200 Hz	ODR = 400 Hz	ODR = 800 Hz
0110	0.1	0.2	0.5	1
0111	0.05	0.1	0.2	0.5
1000	0.02	0.05	0.1	0.2
1001	0.01	0.02	0.05	0.1

## 7.26 CTRL\_REG3\_G (22h)

**Table 71. CTRL\_REG3\_G register**

I1_Int1	I1_Boot	H_Lactive	PP_OD	I2_DRDY	I2_WTM	I2_ORun	I2_Empty
---------	---------	-----------	-------	---------	--------	---------	----------

**Table 72. CTRL\_REG3\_G description**

I1_Int1	Interrupt enable on INT1_G pin. Default value 0. (0: Disable; 1: Enable)
I1_Boot	Boot status available on INT1_G. Default value 0. (0: Disable; 1: Enable)
H_Lactive	Interrupt active configuration on INT1_G. Default value 0. (0: High; 1:Low)
PP_OD	Push-Pull / Open drain. Default value: 0. (0: Push-Pull; 1: Open drain)
I2_DRDY	Date Ready on DRDY_G/INT2_G. Default value 0. (0: Disable; 1: Enable)
I2_WTM	FIFO watermark interrupt on DRDY_G/INT2_G. Default value: 0. (0: Disable; 1: Enable)
I2_ORun	FIFO overrun interrupt on DRDY_G/INT2_G Default value: 0. (0: Disable; 1: Enable)
I2_Empty	FIFO empty interrupt on DRDY_G/INT2_G. Default value: 0. (0: Disable; 1: Enable)

## 7.27 CTRL\_REG4\_G (23h)

**Table 73. CTRL\_REG4\_G register**

BDU	BLE	FS1	FS0	--	0 <sup>(1)</sup>	0 <sup>(1)</sup>	SIM
-----	-----	-----	-----	----	------------------	------------------	-----

1. This bit has to be set to '0' for correct operation.

**Table 74. CTRL\_REG4\_G description**

BDU	Block data update. Default value: 0 (0: continuous update; 1: output registers not updated until MSB and LSB have been read)
BLE	Big/little endian data selection. Default value 0. (0: Data LSB at lower address; 1: Data MSB at lower address)

**Table 74. CTRL\_REG4\_G description (continued)**

FS1-FS0	Full-scale selection. Default value: 00 (00: 250 dps; 01: 500 dps; 10: 2000 dps; 11: 2000 dps)
SIM	SPI serial interface mode selection. Default value: 0 (0: 4-wire interface; 1: 3-wire interface).

## 7.28 CTRL\_REG5\_G (24h)

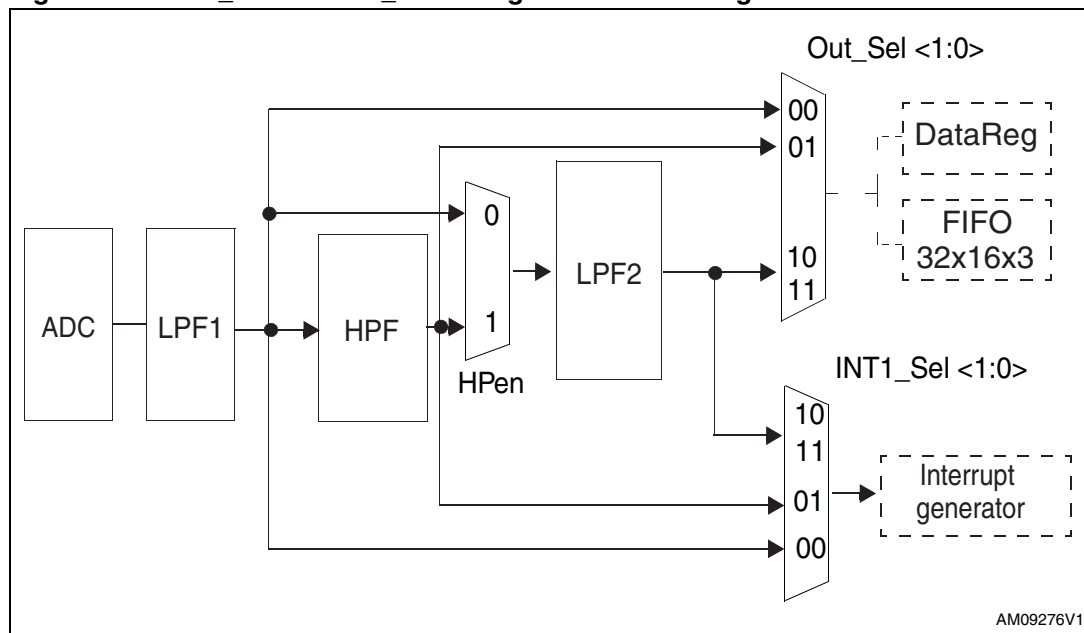
**Table 75. CTRL\_REG5\_G register**

BOOT	FIFO_EN	--	HPen	INT1_Sel1	INT1_Sel0	Out_Sel1	Out_Sel0
------	---------	----	------	-----------	-----------	----------	----------

**Table 76. CTRL\_REG5\_G description**

BOOT	Reboot memory content. Default value: 0 (0: normal mode; 1: reboot memory content)
FIFO_EN	FIFO enable. Default value: 0 (0: FIFO disable; 1: FIFO Enable)
HPen	High-pass filter enable. Default value: 0 (0: HPF disabled; 1: HPF enabled See <a href="#">Figure 12: INT1_Sel and Out_Sel configuration block diagram</a> )
INT1_Sel1- INT1_Sel0	INT1 selection configuration. Default value: 0 (See <a href="#">Figure 12: INT1_Sel and Out_Sel configuration block diagram</a> )
Out_Sel1- Out_Sel0	Out selection configuration. Default value: 0 (See <a href="#">Figure 12: INT1_Sel and Out_Sel configuration block diagram</a> )

**Figure 12. INT1\_Sel and Out\_Sel configuration block diagram**



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**Table 77. Out\_Sel configuration setting**

Hpen	OUT_SEL1	OUT_SEL0	Description
x	0	0	Data in DataReg and FIFO are non-high-pass-filtered
x	0	1	Data in DataReg and FIFO are high-pass-filtered
0	1	x	Data in DataReg and FIFO are low-pass-filtered by LPF2
1	1	x	Data in DataReg and FIFO are high-pass and low-pass-filtered by LPF2

**Table 78. INT\_SEL configuration setting**

Hpen	INT_SEL1	INT_SEL2	Description
x	0	0	Non-high-pass-filtered data are used for interrupt generation
x	0	1	High-pass-filtered data are used for interrupt generation
0	1	x	Low-pass-filtered data are used for interrupt generation
1	1	x	High-pass and low-pass-filtered data are used for interrupt generation

## 7.29 REFERENCE/DATACAPTURE\_G (25h)

**Table 79. REFERENCE/DATACAPTURE\_G register**

Ref7	Ref6	Ref5	Ref4	Ref3	Ref2	Ref1	Ref0
------	------	------	------	------	------	------	------

**Table 80. REFERENCE/DATACAPTURE\_G register description**

Ref 7-Ref0	Reference value for interrupt generation. Default value: 0
------------	--

## 7.30 OUT\_TEMP\_G (26h)

**Table 81. OUT\_TEMP\_G register**

Temp7	Temp6	Temp5	Temp4	Temp3	Temp2	Temp1	Temp0
-------	-------	-------	-------	-------	-------	-------	-------

**Table 82. OUT\_TEMP\_G register description**

Temp7-Temp0	Temperature data (1LSB/deg - 8-bit resolution). The value is expressed as two's complement.
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### 7.31 STATUS\_REG\_G (27h)

**Table 83. STATUS\_REG\_G register**

ZYXOR	ZOR	YOR	XOR	ZYXDA	ZDA	YDA	XDA
-------	-----	-----	-----	-------	-----	-----	-----

**Table 84. STATUS\_REG\_G description**

ZYXOR	X-, Y-, Z-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data has overwritten the previous data before it was read)
ZOR	Z-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data for the Z-axis has overwritten the previous data)
YOR	Y-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data for the Y-axis has overwritten the previous data)
XOR	X-axis data overwrite. Default value: 0 (0: no overwrite has occurred; 1: new data for the X-axis has overwritten the previous data)
ZYXDA	X-, Y-, Z-axis new data available. Default value: 0 (0: a new set of data is not yet available; 1: a new set of data is available)
ZDA	Z-axis new data available. Default value: 0 (0: new data for the Z-axis is not yet available; 1: new data for the Z-axis is available)
YDA	Y-axis new data available. Default value: 0 (0: new data for the Y-axis is not yet available; 1: new data for the Y-axis is available)
XDA	X-axis new data available. Default value: 0 (0: new data for the X-axis is not yet available; 1: new data for the X-axis is available)

### 7.32 OUT\_X\_L\_G (28h), OUT\_X\_H\_G (29h)

This register contains X-axis angular rate data. Values are expressed as two's complement.

### 7.33 OUT\_Y\_L\_G (2Ah), OUT\_Y\_H\_G (2Bh)

This register contains Y-axis angular rate data. Values are expressed as two's complement.

### 7.34 OUT\_Z\_L\_G (2Ch), OUT\_Z\_H\_G (2Dh)

This register contains Z-axis angular rate data. Values are expressed as two's complement.

## 7.35 FIFO\_CTRL\_REG\_G (2Eh)

**Table 85. FIFO\_CTRL\_REG\_G register**

FM2	FM1	FM0	WTM4	WTM3	WTM2	WTM1	WTM0
-----	-----	-----	------	------	------	------	------

**Table 86. FIFO\_CTRL\_REG\_G register description**

FM2-FM0	FIFO mode selection. Default value: 00 (see <a href="#">Table 40: FIFO mode configuration</a> )
WTM4-WTM0	FIFO threshold. Watermark level setting

**Table 87. FIFO mode configuration**

FM2	FM1	FM0	FIFO mode
0	0	0	Bypass mode
0	0	1	FIFO mode
0	1	0	Stream mode
0	1	1	Stream-to-FIFO mode
1	0	0	Bypass-to-Stream mode

## 7.36 FIFO\_SRC\_REG\_G (2Fh)

**Table 88. FIFO\_SRC\_REG\_G register**

WTM	OVRN	EMPTY	FSS4	FSS3	FSS2	FSS1	FSS0
-----	------	-------	------	------	------	------	------

**Table 89. FIFO\_SRC\_REG\_G register description**

WTM	Watermark status. (0: FIFO filling is lower than WTM level; 1: FIFO filling is equal or higher than WTM level)
OVRN	Overflow bit status. (0: FIFO is not completely filled; 1:FIFO is completely filled)
EMPTY	FIFO empty bit. ( 0: FIFO not empty; 1: FIFO empty)
FSS4-FSS1	FIFO stored data level

## 7.37 INT1\_CFG\_G (30h)

This is the configuration register for the interrupt source.

**Table 90. INT1\_CFG\_G register**

AND/OR	LIR	ZHIE	ZLIE	YHIE	YLIE	XHIE	XLIE
--------	-----	------	------	------	------	------	------

**Table 91. INT1\_CFG\_G description**

AND/OR	AND/OR combination of interrupt events. Default value: 0 (0: OR combination of interrupt events 1: AND combination of interrupt events)
LIR	Latch Interrupt Request. Default value: 0 (0: interrupt request not latched; 1: interrupt request latched) Cleared by reading INT1_SRC_G reg.
ZHIE	Enable interrupt generation on Z high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
ZLIE	Enable interrupt generation on Z low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value lower than preset threshold)
YHIE	Enable interrupt generation on Y high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
YLIE	Enable interrupt generation on Y low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value lower than preset threshold)
XHIE	Enable interrupt generation on X high event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value higher than preset threshold)
XLIE	Enable interrupt generation on X low event. Default value: 0 (0: disable interrupt request; 1: enable interrupt request on measured accel. value lower than preset threshold)

### 7.38 INT1\_SRC\_G (31h)

The interrupt source register is a read-only register.

Reading at this address clears the INT1\_SRC\_G IA bit (and eventually the interrupt signal on the INT1\_G pin) and allows the refreshment of data in the INT1\_SRC\_G register if the latched option was chosen.

**Table 92. INT1\_SRC\_G register**

0 <sup>(1)</sup>	IA	ZH	ZL	YH	YL	XH	XL
------------------	----	----	----	----	----	----	----

1. This bit has to be set to '0' for correct operation.

**Table 93. INT1\_SRC\_G description**

IA	Interrupt active. Default value: 0 (0: no interrupt has been generated; 1: one or more interrupts have been generated)
ZH	Z high. Default value: 0 (0: no interrupt, 1: Z high event has occurred)
ZL	Z low. Default value: 0 (0: no interrupt; 1: Z low event has occurred)
YH	Y high. Default value: 0 (0: no interrupt, 1: Y high event has occurred)
YL	Y low. Default value: 0 (0: no interrupt, 1: Y low event has occurred)
XH	X high. Default value: 0 (0: no interrupt, 1: X high event has occurred)
XL	X low. Default value: 0 (0: no interrupt, 1: X low event has occurred)

### 7.39 INT1\_THS\_XH\_G (32h)

**Table 94. INT1\_THS\_XH\_G register**

--	THSX14	THSX13	THSX12	THSX11	THSX10	THSX9	THSX8
----	--------	--------	--------	--------	--------	-------	-------

**Table 95. INT1\_THS\_XH\_G description**

THSX14 - THSX9	Interrupt threshold. Default value: 0000 0000
----------------	---

### 7.40 INT1\_THS\_XL\_G (33h)

**Table 96. INT1\_THS\_XL\_G register**

THSX7	THSX6	THSX5	THSX4	THSX3	THSX2	THSX1	THSX0
-------	-------	-------	-------	-------	-------	-------	-------

**Table 97. INT1\_THS\_XL\_G description**

THSX7 - THSX0	Interrupt threshold. Default value: 0000 0000
---------------	---

### 7.41 INT1\_THS\_YH\_G (34h)

**Table 98. INT1\_THS\_YH\_G register**

--	THSY14	THSY13	THSY12	THSY11	THSY10	THSY9	THSY8
----	--------	--------	--------	--------	--------	-------	-------

**Table 99. INT1\_THS\_YH\_G description**

THSY14 - THSY9	Interrupt threshold. Default value: 0000 0000
----------------	---

### 7.42 INT1\_THS\_YL\_G (35h)

**Table 100. INT1\_THS\_YL\_G register**

THSR7	THSY6	THSY5	THSY4	THSY3	THSY2	THSY1	THSY0
-------	-------	-------	-------	-------	-------	-------	-------

**Table 101. INT1\_THS\_YL\_G description**

THSY7 - THSY0	Interrupt threshold. Default value: 0000 0000
---------------	---

### 7.43 INT1\_THS\_ZH\_G (36h)

**Table 102. INT1\_THS\_ZH\_G register**

--	THSZ14	THSZ13	THSZ12	THSZ11	THSZ10	THSZ9	THSZ8
----	--------	--------	--------	--------	--------	-------	-------

**Table 103. INT1\_THS\_ZH\_G description**

THSZ14 - THSZ9	Interrupt threshold. Default value: 0000 0000
----------------	---

### 7.44 INT1\_THS\_ZL\_G (37h)

**Table 104. INT1\_THS\_ZL\_G register**

THSZ7	THSZ6	THSZ5	THSZ4	THSZ3	THSZ2	THSZ1	THSZ0
-------	-------	-------	-------	-------	-------	-------	-------

**Table 105. INT1\_THS\_ZL\_G description**

THSZ7 - THSZ0	Interrupt threshold. Default value: 0000 0000
---------------	---



## 7.45 INT1\_DURATION\_G (38h)

**Table 106. INT1\_DURATION\_G register**

WAIT	D6	D5	D4	D3	D2	D1	D0
------	----	----	----	----	----	----	----

**Table 107. INT1\_DURATION\_G description**

WAIT	WAIT enable. Default value: 0 (0: disable; 1: enable)
D6 - D0	Duration value. Default value: 000 0000

The **D6 - D0** bits set the minimum duration of the interrupt event to be recognized. The duration of the steps and maximum values depend on the ODR chosen.

The **WAIT** bit has the following meaning:

Wait = '0': the interrupt falls immediately if the signal crosses the selected threshold

Wait = '1': if the signal crosses the selected threshold, the interrupt falls only after the duration has counted the number of samples at the selected data rate, written into the duration counter register.

**Figure 13. Wait disabled**

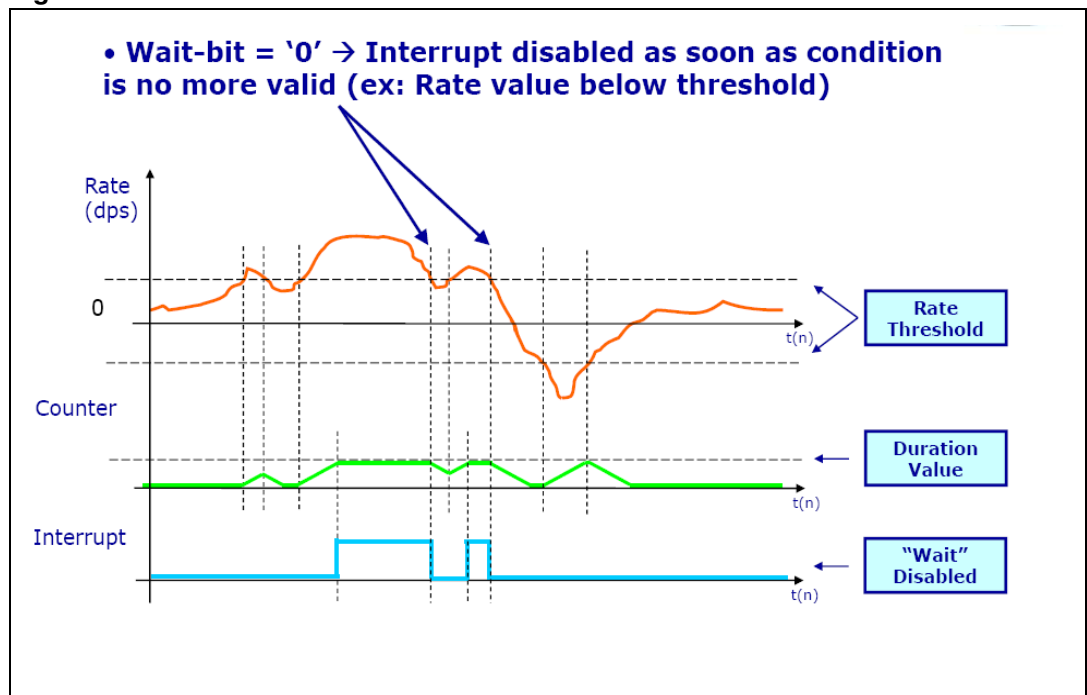
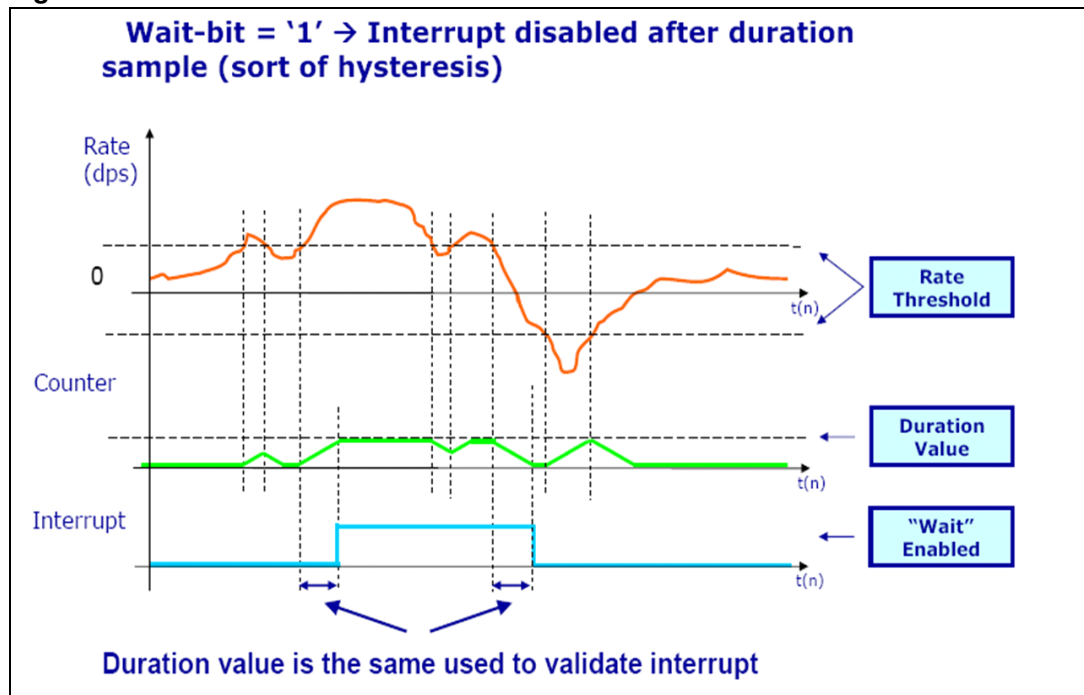


Figure 14. Wait enabled



## 8 Package information

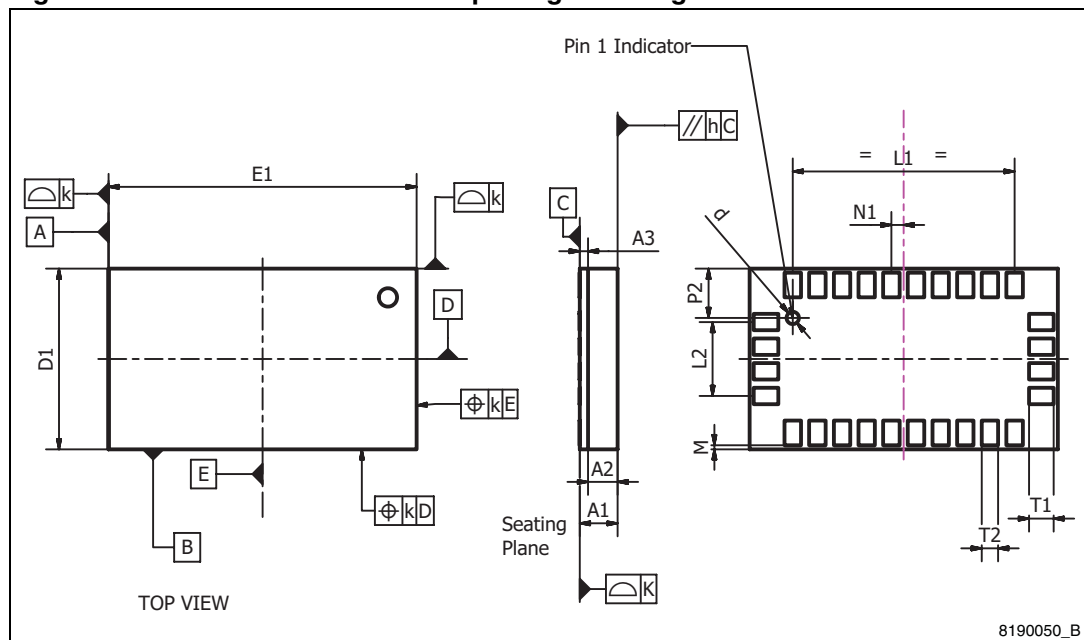
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Table 108. LLGA 7.5 x 4.4 x 1.1 28L mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A1			1.100
A2		0.855	
A3		0.200	
D1	4.250	4.400	4.550
E1	7.350	7.500	7.650
N1		0.300	
L1		5.400	
L2		1.800	
P2		1.200	
T1		0.600	
T2		0.400	
M		0.100	
d		0.3	
k		0.050	
h		0.100	

Figure 15. LLGA 7.5 x 4.4 x 1.1 28L package drawing



## 9 Revision history

Table 109. Document revision history

Date	Revision	Changes
19-Jul-2011	1	First release.

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